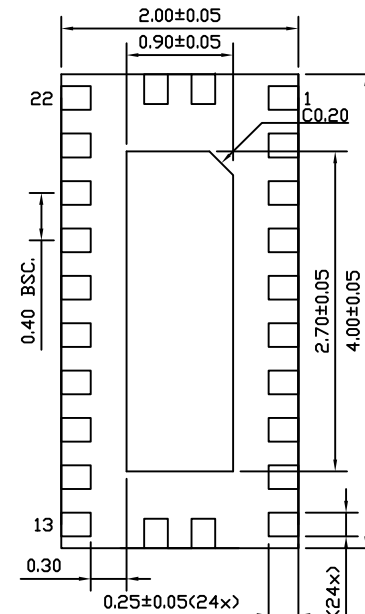
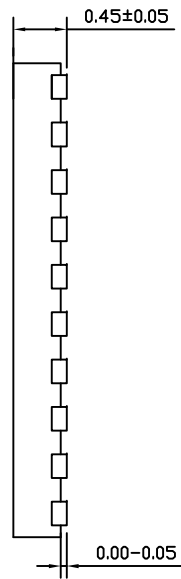
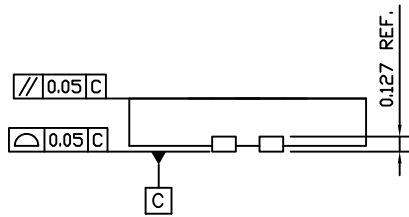
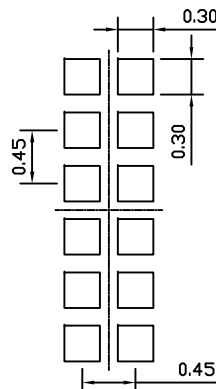


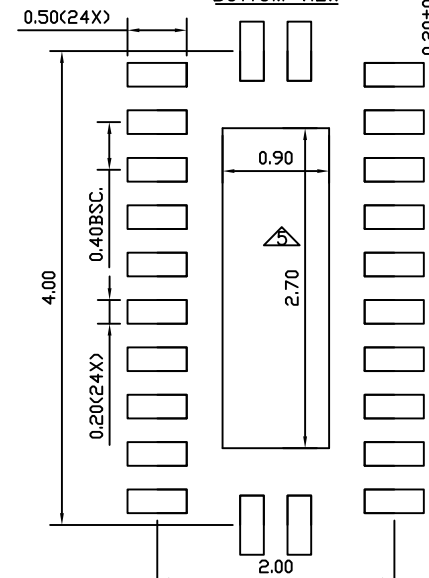
TOP VIEW



BOTTOM VIEW



RECOMMENDED STENCIL DESIGN for EPAD
(0.125mm THICK STENCIL)



RECOMMENDED LAND PATTERN

NOTE :

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. REFER JEDEC MO-288
3. COPLANARITY APPLIES TO THE EXPOSED THERMAL PAD AS WELL AS THE TERMINALS.
4. RECOMMENDED LAND PATTERN IS FOR REFERENCE ONLY.
5. THERMAL PAD SOLDERING AREA (MESH STENCIL DESIGN IS RECOMMENDED).



DATE: 10/20/14

DESCRIPTION: 24-contact, Extra Thin Fine Pitch QFN, X1QFN

PACKAGE CODE: XEA (XEA24)

DOCUMENT CONTROL #: PD-2190

REVISION: --